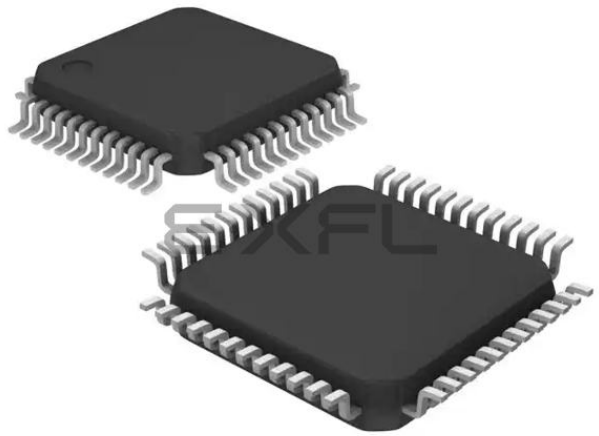

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	ARM® Cortex®-M0
Core Size	32-Bit Single-Core
Speed	45MHz
Connectivity	I²C, IrDA, Microwire, SPI, SSI, SSP, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, POR, WDT
Number of I/O	39
Program Memory Size	96KB (96K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 8x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/lpc1226fbd48-301-1

3. Applications

- eMetering
- Lighting
- Industrial networking
- Alarm systems
- White goods

4. Ordering information

Table 1. Ordering information

Type number	Package		
	Name	Description	Version
LPC1227FBD64/301	LQFP64	LQFP64: plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm	SOT314-2
LPC1226FBD64/301	LQFP64	LQFP64: plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm	SOT314-2
LPC1225FBD64/321	LQFP64	LQFP64: plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm	SOT314-2
LPC1225FBD64/301	LQFP64	LQFP64: plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm	SOT314-2
LPC1224FBD64/121	LQFP64	LQFP64: plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm	SOT314-2
LPC1224FBD64/101	LQFP64	LQFP64: plastic low profile quad flat package; 64 leads; body 10 × 10 × 1.4 mm	SOT314-2
LPC1227FBD48/301	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1226FBD48/301	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1225FBD48/321	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1225FBD48/301	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1224FBD48/121	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2
LPC1224FBD48/101	LQFP48	LQFP48: plastic low profile quad flat package; 48 leads; body 7 × 7 × 1.4 mm	SOT313-2

Table 3. LPC122x pin description *…continued*

Symbol	Pin LQFP48	Pin LQFP64		Start logic input	Type	Reset state [1]	Description
PIO0_17/MOSI	32	44	[2] [3]	no	I/O	I; PU	**PIO0_17 —** General purpose digital input/output pin.
					I/O	-	**MOSI —** Master Out Slave In for SSP/SPI.
PIO0_18/SWCLK/ CT32B0_CAP0/ CT32B0_MAT0	33	45	[2] [3]	no	I/O	I; PU	**PIO0_18 —** General purpose digital input/output pin.
					I	-	**SWCLK —** Serial wire clock, alternate location.
					I	-	**CT32B0_CAP0 —** Capture input, channel 0 for 32-bit timer 0.
					O	-	**CT32B0_MAT0 —** Match output, channel 0 for 32-bit timer 0.
PIO0_19/ACMP0_I0/ CT32B0_CAP1/ CT32B0_MAT1	4	4	[6] [7]	no	I/O	I; PU	**PIO0_19 —** General purpose digital input/output pin.
					I	-	**ACMP0_I0 —** Input 0 for comparator 0.
					I	-	**CT32B0_CAP1 —** Capture input, channel 1 for 32-bit timer 0.
					O	-	**CT32B0_MAT1 —** Match output, channel 1 for 32-bit timer 0
PIO0_20/ACMP0_I1/ CT32B0_CAP2/ CT32B0_MAT2	5	5	[6] [7]	no	I/O	I; PU	**PIO0_20 —** General purpose digital input/output pin.
					I	-	**ACMP0_I1 —** Input 1 for comparator 0.
					I	-	**CT32B0_CAP2 —** Capture input, channel 2 for 32-bit timer 0.
					O	-	**CT32B0_MAT2 —** Match output, channel 2 for 32-bit timer 0.
PIO0_21/ACMP0_I2/ CT32B0_CAP3/ CT32B0_MAT3	6	6	[6] [7]	no	I/O	I; PU	**PIO0_21 —** General purpose digital input/output pin.
					I	-	**ACMP0_I2 —** Input 2 for comparator 0.
					I	-	**CT32B0_CAP3 —** Capture input, channel 3 for 32-bit timer 0.
					O	-	**CT32B0_MAT3 —** Match output, channel 3 for 32-bit timer 0.
PIO0_22/ACMP0_I3	7	7	[6] [7]	no	I/O	I; PU	**PIO0_22 —** General purpose digital input/output pin.
					I	-	**ACMP0_I3 —** Input 3 for comparator 0.
PIO0_23/ ACMP1_I0/ CT32B1_CAP0/ CT32B1_MAT0	8	8	[6] [7]	no	I/O	I; PU	**PIO0_23 —** General purpose digital input/output pin.
					I	-	**ACMP1_I0 —** Input 0 for comparator 1.
					I	-	**CT32B1_CAP0 —** Capture input, channel 0 for 32-bit timer 1.
					O	-	**CT32B1_MAT0 —** Match output, channel 0 for 32-bit timer 1.
PIO0_24/ACMP1_I1/ CT32B1_CAP1/ CT32B1_MAT1	9	9	[6] [7]	no	I/O	I; PU	**PIO0_24 —** General purpose digital input/output pin.
					I	-	**ACMP1_I1 —** Input 1 for comparator 1.
					I	-	**CT32B1_CAP1 —** Capture input, channel 1 for 32-bit timer 1.
					O	-	**CT32B1_MAT1 —** Match output, channel 1 for 32-bit timer 1.
SWDIO/ACMP1_I2/ CT32B1_CAP2/ CT32B1_MAT2/ PIO0_25	10	10	[6] [7]	no	I/O	I; PU	**SWDIO —** Serial wire debug input/output, default location.
					I	-	**ACMP1_I2 —** Input 2 for comparator 1.
					I	-	**CT32B1_CAP2 —** Capture input, channel 2 for 32-bit timer 1.
					O	-	**CT32B1_MAT2 —** Match output, channel 2 for 32-bit timer 1.
					I/O	-	**PIO0_25 —** General purpose digital input/output pin.
SWCLK/ACMP1_I3/ CT32B1_CAP3/ CT32B1_MAT3/ PIO0_26	11	11	[6] [7]	no	I	I; PU	**SWCLK —** Serial wire clock, default location.
					I	-	**ACMP1_I3 —** Input 3 for comparator 1.
					I	-	**CT32B1_CAP3 —** Capture input, channel 3 or 32-bit timer 1.
					O	-	**CT32B1_MAT3 —** Match output, channel 3 for 32-bit timer 1.
					I/O		**PIO0_26 —** General purpose digital input/output pin.

Table 3. LPC122x pin description *…continued*

Symbol	Pin LQFP48	Pin LQFP64		Start logic input	Type	Reset state [1]	Description
PIO0_27/ACMP0_O	12	12	[9]	no	I/O	I; PU	**PIO0_27 —** General purpose digital input/output pin (high-current output driver).
					O	-	**ACMP0_O —** Output for comparator 0.
PIO0_28/ACMP1_O/ CT16B0_CAP0/ CT16B0_MAT0	13	17	[9]	no	I/O	I; PU	**PIO0_28 —** General purpose digital input/output pin (high-current output driver).
					O	-	**ACMP1_O —** Output for comparator 1.
					I	-	**CT16B0_CAP0 —** Capture input, channel 0 for 16-bit timer 0.
					O	-	**CT16B0_MAT0 —** Match output, channel 0 for 16-bit timer 0.
PIO0_29/ROSC/ CT16B0_CAP1/ CT16B0_MAT1	14	18	[9]	no	I/O	I; PU	**PIO0_29 —** General purpose digital input/output pin (high-current output driver).
					I/O	-	**ROSC —** Relaxation oscillator for 555 timer applications.
					I	-	**CT16B0_CAP1 —** Capture input, channel 1 for 16-bit timer 0.
					O	-	**CT16B0_MAT1 —** Match output, channel 1 for 16-bit timer 0.
R/PIO0_30/AD0	34	46	[6] [3]	no	I	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
					I/O	-	**PIO0_30 —** General purpose digital input/output pin.
					I	-	**AD0 —** A/D converter, input 0.
R/PIO0_31/AD1	35	47	[6] [3]	no	I	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
					I/O	-	**PIO0_31 —** General purpose digital input/output pin.
					I	-	**AD1 —** A/D converter, input 1.
PIO1_0 to PIO1_6					I/O		**Port 1 —** Port 1 is a 32-bit I/O port with individual direction and function controls for each bit. The operation of port 1 pins depends on the function selected through the IOCONFIG register block. Pins PIO1_7 through PIO1_31 are not available.
R/PIO1_0/AD2	36	48	[6] [3]	no	O	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.
					I/O	-	**PIO1_0 —** General purpose digital input/output pin.
					I	-	**AD2 —** A/D converter, input 2.
R/PIO1_1/AD3	37	49	[6] [3]	no	I	I; PU	**R —** Reserved. Configure for an alternate function in the IOCONFIG block.Do not pull this pin LOW at reset.
					I/O	-	**PIO1_1 —** General purpose digital input/output pin.
					I	-	**AD3 —** A/D converter, input 3.
PIO1_2/SWDIO/AD4	38	50	[6] [3]	no	I/O	I; PU	**PIO1_2 —** General purpose digital input/output pin.
					I/O	-	**SWDIO —** Serial wire debug input/output, alternate location.
					I	-	**AD4 —** A/D converter, input 4.
PIO1_3/AD5/WAKEUP	39	51	[8] [3]	no	I/O	I; PU	**PIO1_3 —** General purpose digital input/output pin.
					I	-	**AD5 —** A/D converter, input 5.
					I	-	**WAKEUP —** Deep power-down mode wake-up pin.
PIO1_4/AD6	40	52	[6] [3]	no	I/O	I; PU	**PIO1_4 —** General purpose digital input/output pin.
					I	-	**AD6 —** A/D converter, input 6.

Table 3. LPC122x pin description *…continued*

Symbol	Pin LQFP48	Pin LQFP64		Start logic input	Type	Reset state [1]	Description
PIO2_6/ CT32B0_CAP2/ CT32B0_MAT2/DCD0	-	35	[2] [3]	no	I/O	I; PU	**PIO2_6 —** General purpose digital input/output pin.
					I	-	**CT32B0_CAP2 —** Capture input, channel 2 for 32-bit timer 0.
					O	-	**CT32B0_MAT2 —** Match output, channel 2 for 32-bit timer 0.
					I	-	**DCD0 —** Data Carrier Detect input for UART0.
PIO2_7/ CT32B0_CAP3/ CT32B0_MAT3/DSR0	-	36	[2] [3]	no	I/O	I; PU	**PIO2_7 —** General purpose digital input/output pin.
					I	-	**CT32B0_CAP3 —** Capture input, channel 3 for 32-bit timer 0.
					O	-	**CT32B0_MAT3 —** Match output, channel 3 for 32-bit timer 0.
					I	-	**DSR0 —** Data Set Ready input for UART0.
PIO2_8/ CT32B1_CAP0/ CT32B1_MAT0	-	59	[2] [3]	no	I/O	I; PU	**PIO2_8 —** General purpose digital input/output pin.
					I	-	**CT32B1_CAP0 —** Capture input, channel 0 for 32-bit timer 1.
					O	-	**CT32B1_MAT0 —** Match output, channel 0 for 32-bit timer 1.
PIO2_9/ CT32B1_CAP1/ CT32B1_MAT1	-	60	[2] [3]	no	I/O	I; PU	**PIO2_9 —** General purpose digital input/output pin.
					I	-	**CT32B1_CAP1 —** Capture input, channel 1 for 32-bit timer 1.
					O	-	**CT32B1_MAT1 —** Match output, channel 1 for 32-bit timer 1.
PIO2_10/ CT32B1_CAP2/ CT32B1_MAT2/TXD1	-	61	[2] [3]	no	I/O	I; PU	**PIO2_10 —** General purpose digital input/output pin.
					I	-	**CT32B1_CAP2 —** Capture input, channel 2 for 32-bit timer 1.
					O	-	**CT32B1_MAT2 —** Match output, channel 2 for 32-bit timer 1.
					O	-	**TXD1 —** Transmitter output for UART1.
PIO2_11/ CT32B1_CAP3/ CT32B1_MAT3/RXD1	-	62	[2] [3]	no	I/O	I; PU	**PIO2_11 —** General purpose digital input/output pin.
					I	-	**CT32B1_CAP3 —** Capture input, channel 3 for 32-bit timer 1.
					O	-	**CT32B1_MAT3 —** Match output, channel 3 for 32-bit timer 1.
					I	-	**RXD1 —** Receiver input for UART1.
PIO2_12/RXD1	-	13	[2] [3]	no	I/O	I; PU	**PIO2_12 —** General purpose digital input/output pin.
					I	-	**RXD1 —** Receiver input for UART1.
PIO2_13/TXD1	-	14	[2] [3]	no	I/O	I; PU	**PIO2_13 —** General purpose digital input/output pin.
					O	-	**TXD1 —** Transmitter output for UART1.
PIO2_14	-	15	[2] [3]	no	I/O	I; PU	**PIO2_14 —** General purpose digital input/output pin.
PIO2_15	-	16	[2] [3]	no	I/O	I; PU	**PIO2_15 —** General purpose digital input/output pin.
RTCXIN	46	58	[10]	-	I	-	Input to the 32 kHz oscillator circuit.
RTCXOUT	45	57	[10]	-	O	-	Output from the 32 kHz oscillator amplifier.
XTALIN	1	1		-	I	-	Input to the system oscillator circuit and internal clock generator circuits.
XTALOUT	2	2		-	O	-	Output from the system oscillator amplifier.
VREF_CMP	3	3		-	I	-	Reference voltage for comparator.

Table 4. Pin multiplexing

Peripheral	Function	Type	Available on ports:		
ADC	AD0	I	PIO0_30	-	-
	AD1	I	PIO0_31	-	-
	AD2	I	PIO1_0	-	-
	AD3	I	PIO1_1	-	-
	AD4	I	PIO1_2	-	-
	AD5	I	PIO1_3	-	-
	AD6	I	PIO1_4	-	-
	AD7	I	PIO1_5	-	-
CT16B0	CT16B0_CAP0	I	PIO0_11	PIO0_28	PIO2_0
	CT16B0_CAP1	I	PIO0_12	PIO0_29	PIO2_1
	CT16B0_MAT0	O	PIO0_11	PIO0_28	PIO2_0
	CT16B0_MAT1	O	PIO0_12	PIO0_29	PIO2_1
CT16B1	CT16B1_CAP0	I	PIO0_15	PIO1_5	PIO2_2
	CT16B1_CAP1	I	PIO0_16	PIO1_6	PIO2_3
	CT16B1_MAT0	O	PIO0_15	PIO1_5	PIO2_2
	CT16B1_MAT1	O	PIO0_16	PIO1_6	PIO2_3
CT32B0	CT32B0_CAP0	I	PIO0_1	PIO0_18	PIO2_4
	CT32B0_CAP1	I	PIO0_2	PIO0_19	PIO2_5
	CT32B0_CAP2	I	PIO0_3	PIO0_20	PIO2_6
	CT32B0_CAP3	I	PIO0_4	PIO0_21	PIO2_7
	CT32B0_MAT0	O	PIO0_1	PIO0_18	PIO2_4
	CT32B0_MAT1	O	PIO0_2	PIO0_19	PIO2_5
	CT32B0_MAT2	O	PIO0_3	PIO0_20	PIO2_6
	CT32B0_MAT3	O	PIO0_4	PIO0_21	PIO2_7
CT32B1	CT32B1_CAP0	I	PIO0_6	PIO0_23	PIO2_8
	CT32B1_CAP1	I	PIO0_7	PIO0_24	PIO2_9
	CT32B1_CAP2	I	PIO0_8	PIO0_25	PIO2_10
	CT32B1_CAP3	I	PIO0_9	PIO0_26	PIO2_11
	CT32B1_MAT0	O	PIO0_6	PIO0_23	PIO2_8
	CT32B1_MAT1	O	PIO0_7	PIO0_24	PIO2_9
	CT32B1_MAT2	O	PIO0_8	PIO0_25	PIO2_10
	CT32B1_MAT3	O	PIO0_9	PIO0_26	PIO2_11
UART0	RXD0	I	PIO0_1	PIO2_1	-
	TXD0	O	PIO0_2	PIO2_2	-
	$\overline{\text{CTS0}}$	I	PIO0_7	PIO2_4	-
	$\overline{\text{DCD0}}$	I	PIO0_5	PIO2_6	-
	$\overline{\text{DSR0}}$	I	PIO0_4	PIO2_7	-
	$\overline{\text{DTR0}}$	O	PIO0_3	PIO2_3	-
	$\overline{\text{RI0}}$	I	PIO0_6	PIO2_5	-
	$\overline{\text{RTS0}}$	O	PIO0_0	PIO2_0	-

Table 4. Pin multiplexing

Peripheral	Function	Type	Available on ports:		
UART1	RXD1	I	PIO0_8	PIO2_11	PIO2_12
	TXD1	O	PIO0_9	PIO2_10	PIO2_13
SSP/SPI	SCK	I/O	PIO0_14	-	-
	MISO	I/O	PIO0_16	-	-
	MOSI	I/O	PIO0_17	-	-
	SSEL	I/O	PIO0_15	-	-
I2C	SCL	I/O	PIO0_10	-	-
	SDA	I/O	PIO0_11	-	-
SWD	SWCLK[1]	I	PIO0_18	PIO0_26	-
	SWDIO[1]	I/O	PIO0_25	PIO1_2	-
Reset	$\overline{\text{RESET}}$	I	PIO0_13	-	-
Clockout pin	CLKOUT	O	PIO0_12	-	-

[1] After reset, the SWD functions are selected by default on pins PIO0_26 and PIO0_25.

7. Functional description

7.1 ARM Cortex-M0 processor

The ARM Cortex-M0 is a general purpose, 32-bit microprocessor, which offers high performance and very low power consumption.

7.1.1 System tick timer

The ARM Cortex-M0 includes a System Tick timer (SYSTICK) that is intended to generate a dedicated SYSTICK exception at a 10 ms interval.

7.2 On-chip flash program memory

The LPC122x contain up to 128 kB of on-chip flash memory.

7.3 On-chip SRAM

The LPC122x contain a total of up to 8 kB on-chip static RAM memory.

7.4 Memory map

The LPC122x incorporates several distinct memory regions, shown in the following figures. Figure 4 shows the overall map of the entire address space from the user program viewpoint following reset. The interrupt vector area supports address remapping.

The AHB peripheral area is 2 megabyte in size, and is divided to allow for up to 128 peripherals. The APB peripheral area is 512 kB in size and is divided to allow for up to 32 peripherals. Each peripheral of either type is allocated 16 kilobytes of space. This allows simplifying the address decoding for each peripheral.

- In the LPC122x, the NVIC supports 32 vectored interrupts. In addition, up to 12 of the individual GPIO inputs are NVIC-vector capable.
- Four programmable interrupt priority levels with hardware priority level masking.
- Software interrupt generation.
- Non-maskable Interrupt (NMI) can be programmed to use any of the peripheral interrupts. The NMI is not available on an external pin.

7.5.2 Interrupt sources

Each peripheral device has one interrupt line connected to the NVIC but may have several interrupt flags. Individual interrupt flags may also represent more than one interrupt source.

Any GPIO pin (total of up to 55 pins) regardless of the selected function, can be programmed to generate an interrupt on a level, a rising edge or falling edge, or both.

7.6 IOCONFIG block

The IOCONFIG block allows selected pins of the microcontroller to have more than one function. Configuration registers control the multiplexers to allow connection between the pin and the on-chip peripherals.

Peripherals should be connected to the appropriate pins prior to being activated and prior to any related interrupt(s) being enabled. Activity of any enabled peripheral function that is not mapped to a related pin should be considered undefined.

7.6.1 Features

- Programmable pull-up resistor.
- Programmable digital glitch filter.
- Programmable input inverter.
- Programmable drive current.
- Programmable open-drain mode.

7.7 Micro DMA controller

The micro DMA controller enables memory-to-memory, memory-to-peripheral, and peripheral-to-memory data transfers. The supported peripherals are: UART0 (transmit and receive), UART1 (transmit and receive), SSP/SPI (transmit and receive), ADC, RTC, 32-bit counter/timer 0 (match output channels 0 and 1), 32-bit counter/timer 1 (match output channels 0 and 1), 16-bit counter/timer 0 (match output channel 0), 16-bit counter/timer 1 (match output channel 0), comparator 0, comparator 1, GPIO0 to GPIO2.

7.7.1 Features

- Single AHB-Lite master for transferring data using a 32-bit address bus and 32-bit data bus.
- 21 DMA channels.
- Handshake signals and priority level programmable for each channel.
- Each priority level arbitrates using a fixed priority that is determined by the DMA channel number.

- Supports memory-to-memory, memory-to-peripheral, and peripheral-to-memory transfers.
- Supports multiple DMA cycle types and multiple DMA transfer widths.
- Performs all DMA transfers using the single AHB-Lite burst type.

7.8 CRC engine

The Cyclic Redundancy Check (CRC) engine with programmable polynomial settings supports several CRC standards commonly used. To save system power and bus bandwidth, the CRC engine supports DMA transfers.

7.8.1 Features

- Supports three common polynomials CRC-CCITT, CRC-16, and CRC-32.
  - CRC-CCITT: $x^{16} + x^{12} + x^5 + 1$
  - CRC-16: $x^{16} + x^{15} + x^2 + 1$
  - CRC-32: $x^{32} + x^{26} + x^{23} + x^{22} + x^{16} + x^{12} + x^{11} + x^{10} + x^8 + x^7 + x^5 + x^4 + x^2 + x + 1$
- Bit order reverse and 1's complement programmable setting for input data and CRC sum.
- Programmable seed number setting.
- Supports CPU programmed I/O or DMA back-to-back transfer.
- Accept any size of data width per write: 8, 16 or 32-bit.
  - 8-bit write: 1-cycle operation
  - 16-bit write: 2-cycle operation (8-bit $\times$ 2-cycle)
  - 32-bit write: 4-cycle operation (8-bit $\times$ 4-cycle)

7.9 Fast general purpose parallel I/O

Device pins that are not connected to a specific peripheral function are controlled by the GPIO registers. Pins may be dynamically configured as inputs or outputs. Separate registers allow setting or clearing any number of outputs simultaneously. The value of the output register may be read back as well as the current state of the port pins.

7.9.1 Features

- Bit level set and clear registers allow a single instruction to set or clear any number of bits in one port.
- Direction control of individual bits.
- All I/O default to inputs after reset.

7.10 UARTs

The LPC122x contains two UARTs. UART0 supports full modem control and RS-485/9-bit mode and allows both software address detection and automatic hardware address detection using 9-bit mode.

The UARTs include a fractional baud rate generator. Standard baud rates such as 115200 Bd can be achieved with any crystal frequency above 2 MHz.

- Bidirectional data transfer between masters and slaves.
- Multi-master bus (no central master).
- Arbitration between simultaneously transmitting masters without corruption of serial data on the bus.
- Serial clock synchronization allows devices with different bit rates to communicate via one serial bus.
- Serial clock synchronization can be used as a handshake mechanism to suspend and resume serial transfer.
- The I^2C-bus can be used for test and diagnostic purposes.
- The I^2C-bus controller supports multiple address recognition and a bus monitor mode.

7.13 10-bit ADC

The LPC122x contains one ADC. It is a single 10-bit successive approximation ADC with eight channels.

7.13.1 Features

- 10-bit successive approximation ADC.
- Input multiplexing among 8 pins.
- Power-down mode.
- Measurement range 0 V to $V_{DD(3V3)}$.
- 10-bit conversion time of 257 kHz.
- Burst conversion mode for single or multiple inputs.
- Optional conversion on transition of input pin or counter/timer match signal.
- Individual result registers for each ADC channel to reduce interrupt overhead.

7.14 Comparator block

The comparator block consists of two analog comparators.

7.14.1 Features

- Up to six selectable external sources per comparator; fully configurable on either positive or negative comparator input channels.
- BOD 0.9 V internal reference voltage selectable on both comparators; configurable on either positive or negative comparator input channels.
- 32-stage voltage ladder internal reference voltage selectable on both comparators; configurable on either positive or negative comparator input channels.
- Voltage ladder source voltage is selectable from an external pin or an internal 3.3 V voltage rail if external power source is not available.
- Voltage ladder can be separately powered down for applications only requiring the comparator function.
- Relaxation oscillator circuitry output for a feedback 555-style timer application.
- Common interrupt connected to NVIC.
- Comparator outputs selectable as synchronous or asynchronous.

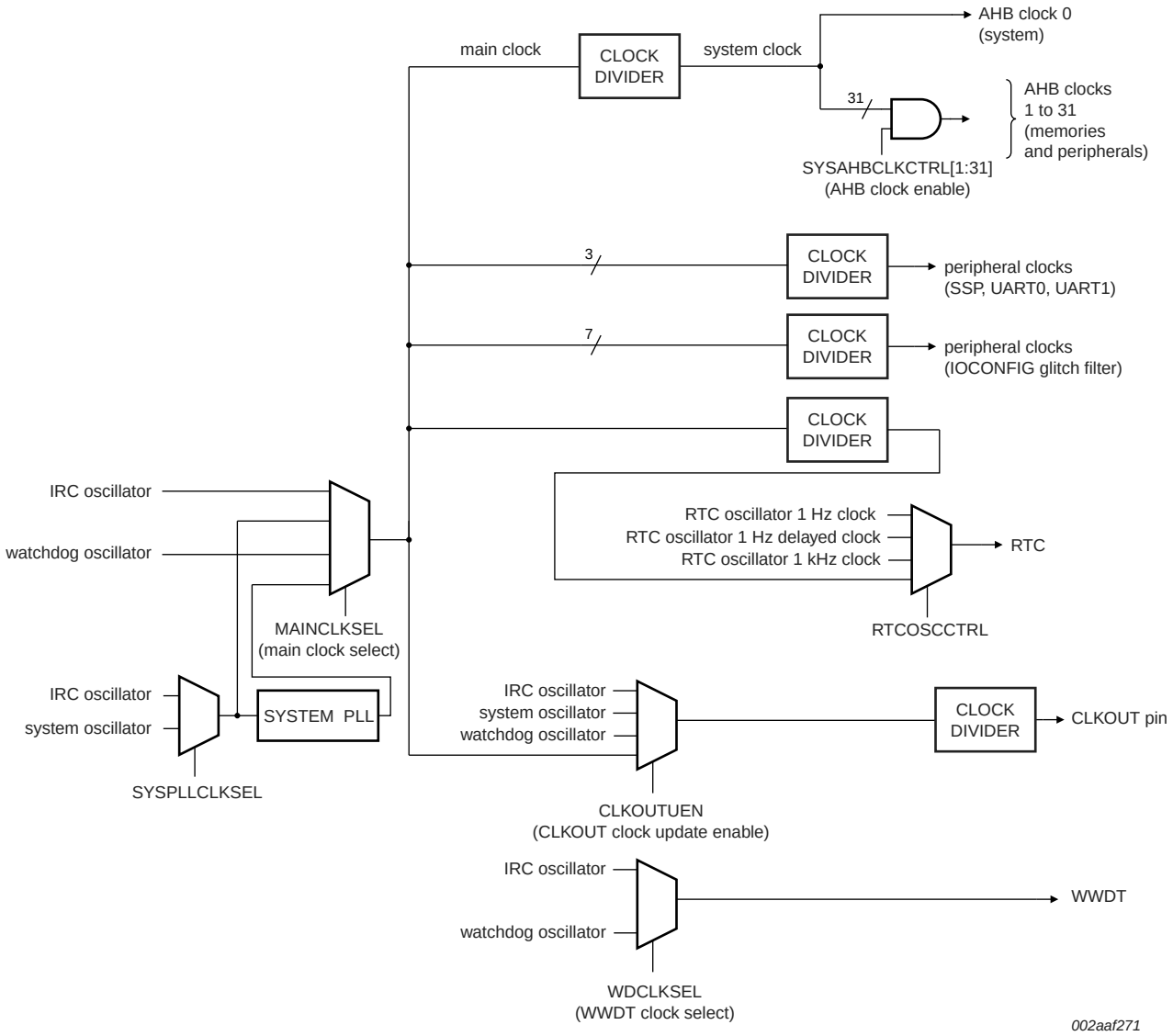


Fig 5. LPC122x clocking generation block diagram

7.18.1.1 Internal RC oscillator

The IRC may be used as the clock source for the WDT, and/or as the clock that drives the PLL and subsequently the CPU. The nominal IRC frequency is 12 MHz. The IRC is trimmed to 1 % accuracy over the entire voltage and temperature range.

Upon power-up or any chip reset, the LPC122x use the IRC as the clock source. Software may later switch to one of the other available clock sources.

7.18.1.2 System oscillator

The system oscillator can be used as the clock source for the CPU, with or without using the PLL.

In Sleep mode, execution of instructions is suspended until either a reset or interrupt occurs. Peripheral functions continue operation during Sleep mode and may generate interrupts to cause the processor to resume execution. Sleep mode eliminates dynamic power used by the processor itself, memory systems and related controllers, and internal buses.

7.18.5.2 Deep-sleep mode

In Deep-sleep mode, the chip is in Sleep mode, and in addition all analog blocks are shut down. As an exception, the user has the option to keep the watchdog oscillator and the BOD circuit running for self-timed wake-up and BOD protection. Deep-sleep mode allows for additional power savings.

The GPIO pins PIO0_0 to PIO0_11 (up to 12 pins total) and the RTC match interrupt can serve as a wake-up input to the start logic to wake up the chip from Deep-sleep mode.

Unless the watchdog oscillator is selected to run in Deep-sleep mode, the clock source should be switched to IRC before entering Deep-sleep mode, because the IRC can be switched on and off glitch-free.

7.18.5.3 Deep power-down mode

In Deep power-down mode, power is shut off to the entire chip with the exception of the Real Time Clock, the four general-purpose registers, and the WAKEUP pin. The LPC122x can wake up from Deep power-down mode via the WAKEUP pin or the RTC match interrupt.

When entering Deep power-down mode, an external pull-up resistor is required on the WAKEUP pin to hold it HIGH. The $\overline{\text{RESET}}$ pin must also be held HIGH to prevent it from floating while in Deep power-down mode.

7.19 System control

7.19.1 Start logic

The start logic connects external pins to corresponding interrupts in the NVIC. Each pin shown in Table 3 as input to the start logic has an individual interrupt in the NVIC interrupt vector table. The start logic pins can serve as external interrupt pins when the chip is running. In addition, an input signal on the start logic pins can wake up the chip from Deep-sleep mode when all clocks are shut down.

The start logic must be configured in the system configuration block and in the NVIC before being used.

7.19.2 Reset

Reset has four sources on the LPC122x: the $\overline{\text{RESET}}$ pin, the Watchdog reset, power-on reset (POR), and the BrownOut Detection (BOD) circuit. The $\overline{\text{RESET}}$ pin is a Schmitt trigger input pin. Assertion of chip reset by any source, once the operating voltage attains a usable level, starts the IRC and initializes the flash controller.

When the internal Reset is removed, the processor begins executing at address 0, which is initially the Reset vector mapped from the boot block. At that point, all of the processor and peripheral registers have been initialized to predetermined values.

An external pull-up resistor is required on the $\overline{\text{RESET}}$ pin if Deep power-down mode is used.

7.19.3 Brownout detection

The LPC122x includes four levels for monitoring the voltage on the $V_{DD(3V3)}$ pin. If this voltage falls below one of the four selected levels, the BOD asserts an interrupt signal to the NVIC. This signal can be enabled for interrupt in the Interrupt Enable Register in the NVIC in order to cause a CPU interrupt; if not, software can monitor the signal by reading a dedicated status register. An additional threshold level can be selected to cause a forced reset of the chip.

7.19.4 Code security (Code Read Protection - CRP)

This feature of the LPC122x allows user to enable different levels of security in the system so that access to the on-chip flash and use of the SWD and ISP can be restricted. When needed, CRP is invoked by programming a specific pattern into a dedicated flash location. IAP commands are not affected by the CRP.

There are three levels of Code Read Protection:

1. CRP1 disables access to chip via the SWD and allows partial flash update (excluding flash sector 0) using a limited set of the ISP commands. This mode is useful when CRP is required and flash field updates are needed but all sectors can not be erased.
2. CRP2 disables access to chip via the SWD and only allows full flash erase and update using a reduced set of the ISP commands.
3. Running an application with level CRP3 selected fully disables any access to chip via the SWD pins and the ISP. This mode effectively disables ISP override using PIO0_12 pin, too. It is up to the user's application to provide (if needed) flash update mechanism using IAP calls or call reinvoke ISP command to enable flash update via UART0.

CAUTION

If level three Code Read Protection (CRP3) is selected, no future factory testing can be performed on the device.

In addition to the three CRP levels, sampling of pin PIO0_12 for valid user code can be disabled.

7.19.5 APB interface

The APB peripherals are located on one APB bus.

7.19.6 AHB-Lite

The AHB-Lite connects the CPU bus of the ARM Cortex-M0 to the flash memory, the main static RAM, and the Boot ROM.

7.19.7 External interrupt inputs

All GPIO pins can be level or edge sensitive interrupt inputs.

7.20 Emulation and debugging

Debug functions are integrated into the ARM Cortex-M0. Serial wire debug is supported.

7.21 Integer division routines

The LPC122x contain performance-optimized integer division routines with support for up to 32-bit width in the numerator and denominator. Routines for signed and unsigned division and division with remainder are available. The integer division routines are ROM-based to reduce code-size.

10. Static characteristics

Table 7. Static characteristics

T_{amb} = −40 °C to +85 °C, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
$V_{DD(IO)}$	input/output supply voltage	on pin $V_{DD(IO)}$	3.0	3.3	3.6	V
$V_{DD(3V3)}$	supply voltage (3.3 V)		3.0	3.3	3.6	V
I_{DD}	supply current	Active mode; $V_{DD(3V3)}$ = 3.3 V; T_{amb} = 25 °C; code `while(1){}` executed from flash				
		all peripherals disabled:				
		CCLK = 12 MHz	-	4.6	-	mA
		CCLK = 24 MHz	-	9	-	mA
		CCLK = 33 MHz	-	12.2	-	mA
		all peripherals enabled:				
		CCLK = 12 MHz	-	6.6	-	mA
		CCLK = 24 MHz	-	10.9	-	mA
		CCLK = 33 MHz	-	14.1	-	mA
		Sleep mode; $V_{DD(3V3)}$ = 3.3 V; T_{amb} = 25 °C; all peripherals disabled				
		CCLK = 12 MHz	-	1.8	-	mA
		CCLK = 24 MHz	-	3.3	-	mA
		CCLK = 33 MHz	-	4.4	-	mA
		Deep-sleep mode; $V_{DD(3V3)}$ = 3.3 V; T_{amb} = 25 °C	-	30	-	μA
		Deep power-down mode; $V_{DD(3V3)}$ = 3.3 V; T_{amb} = 25 °C	-	720	-	nA
Normal-drive output pins (Standard port pins, RESET)						
I_{IL}	LOW-level input current	V_I = 0 V;	-	-	100	nA
I_{IH}	HIGH-level input current	$V_I = V_{DD(IO)}$;	-	-	100	nA
I_{OZ}	OFF-state output current	V_O = 0 V; $V_O = V_{DD(IO)}$;	-	-	100	nA
V_I	input voltage	pin configured to provide a digital function [2][3][4]	0	-	$V_{DD(IO)}$	V
V_O	output voltage	output active	0	-	$V_{DD(IO)}$	V
V_{IH}	HIGH-level input voltage		$0.7V_{DD(IO)}$	-	-	V

Table 7. Static characteristics *…continued*
T_{amb} = −40 °C to +85 °C, unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
V_{IL}	LOW-level input voltage			-	-	$0.3V_{DD(IO)}$	V
V_{hys}	hysteresis voltage			-	0.4	-	V
V_{OH}	HIGH-level output voltage	low mode; I_{OH} = −2 mA		$V_{DD(IO)}$ − 0.4	-	-	V
		high mode; I_{OH} = −4 mA		$V_{DD(IO)}$ − 0.4	-	-	V
V_{OL}	LOW-level output voltage	low mode; I_{OL} = 2 mA		-	-	0.4	V
		high mode; I_{OL} = 4 mA				0.4	
I_{OH}	HIGH-level output current	low mode; $V_{OH} = V_{DD(IO)}$ − 0.4 V		−2	-	-	mA
		high mode; $V_{OH} = V_{DD(IO)}$ − 0.4 V		−4	-	-	mA
I_{OL}	LOW-level output current	low mode; V_{OL} = 0.4 V		2	-	-	mA
		high mode; V_{OL} = 0.4 V		4	-	-	mA
I_{OHS}	HIGH-level short-circuit output current	V_{OH} = 0 V	[5]	-	-	−45	mA
I_{OLS}	LOW-level short-circuit output current	$V_{OL} = V_{DDA}$	[5]	-	-	50	mA
I_{pu}	pull-up current	V_I = 0 V		−50	−80	−100	μA
High-drive output pins (PIO0_27, PIO0_28, PIO0_29, PIO0_12)							
I_{IL}	LOW-level input current	V_I = 0 V;		-	-	100	nA
I_{IH}	HIGH-level input current	$V_I = V_{DD(IO)}$;		-	-	100	nA
I_{OZ}	OFF-state output current	V_O = 0 V; $V_O = V_{DD(IO)}$;		-	-	100	nA
V_I	input voltage	pin configured to provide a digital function	[2][3] [4]	0	-	$V_{DD(IO)}$	V
V_O	output voltage	output active		0	-	$V_{DD(IO)}$	V
V_{IH}	HIGH-level input voltage			$0.7V_{DD(IO)}$	-	-	V
V_{IL}	LOW-level input voltage		-	-	$0.3V_{DD(IO)}$	-	-
V_{hys}	hysteresis voltage				-	-	V
V_{OH}	HIGH-level output voltage	low mode; I_{OH} = −20 mA		$V_{DD(IO)}$ − 0.7	-	-	V
		high mode; I_{OH} = −28 mA		$V_{DD(IO)}$ − 0.7	-	-	V
V_{OL}	LOW-level output voltage	low mode; I_{OL} = 12 mA		-	-	0.4	V
		high mode; I_{OL} = 18 mA		-	-	0.4	V

10.1 Peripheral power consumption

The supply current per peripheral is measured as the difference in supply current between the peripheral block enabled and the peripheral block disabled in the SYSAHBCLKCFG and PDRUNCFG (for analog blocks) registers. All other blocks are disabled in both registers and no code is executed. Measured on a typical sample at T_{amb} = 25 °C and $V_{DD(3V3)}$ = 3.3 V.

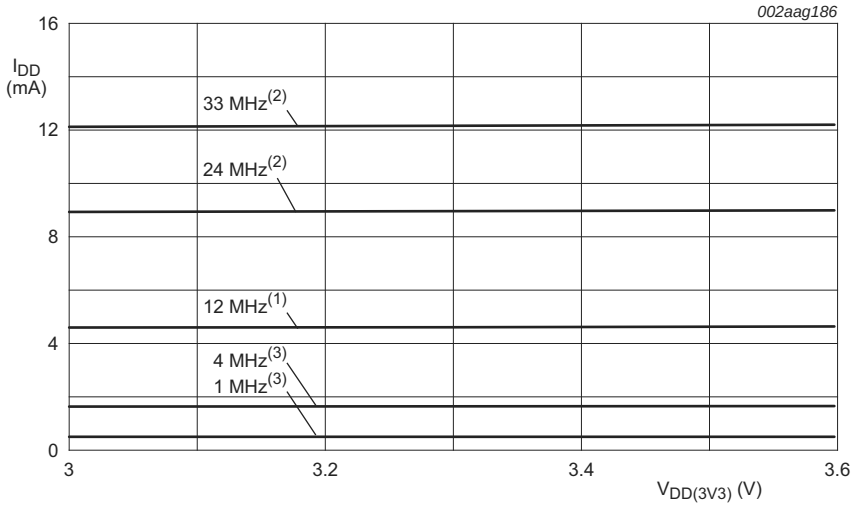
Table 8. Peripheral power consumption

Peripheral	Typical current consumption I_{DD} in mA				
	Frequency independent	24 MHz		12 MHz	
		system oscillator + PLL	IRC + PLL	system oscillator	IRC
IRC	0.29	-	-	-	-
PLL (PLL output frequency = 24 MHz)	1.87	-	-	-	-
WDosc (WDosc output frequency = 500 kHz)	0.25	-	-	-	-
BOD	0.06	-	-	-	-
Analog comparator 0/1	-	0.05	0.05	0.03	0.02
ADC	-	1.86	1.85	1.61	1.61
CRC engine	-	0.04	0.04	0.02	0.02
16-bit timer 0 (CT16B0)	-	0.09	0.09	0.04	0.04
16-bit timer 1 (CT16B1)	-	0.09	0.09	0.04	0.04
32-bit timer 0 (CT32B0)	-	0.08	0.08	0.04	0.04
32-bit timer 1 (CT32B1)	-	0.08	0.08	0.04	0.04
GPIO0	-	0.34	0.34	0.17	0.17
GPIO1	-	0.34	0.34	0.17	0.17
GPIO2	-	0.36	0.37	0.18	0.18
I2C	-	0.09	0.09	0.05	0.05
IOCON	-	0.09	0.10	0.05	0.05
RTC	-	0.10	0.10	0.05	0.05
SSP	-	0.30	0.29	0.15	0.15
UART0	-	0.52	0.51	0.26	0.26
UART1	-	0.52	0.51	0.26	0.26
DMA	-	0.18	0.18	0.09	0.09
WWDT	-	0.06	0.06	0.03	0.03

10.2 Power consumption

Power measurements in Active, Sleep, and Deep-sleep modes were performed under the following conditions (see *LPC122x user manual*):

- Active mode: all GPIO pins set to input with external pull-up resistors.
- Sleep and Deep-sleep modes: all GPIO pins set to output driving LOW.
- Deep power-down mode: all GPIO pins set to input with external pull-up resistors.



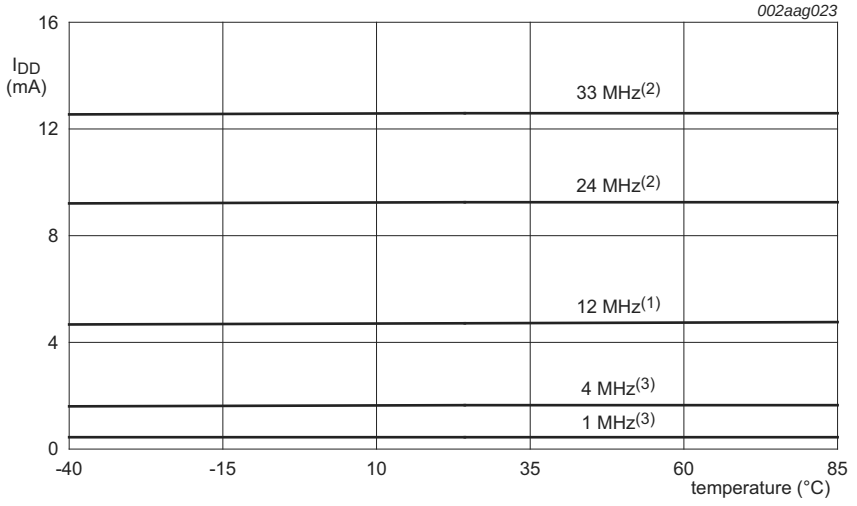
Conditions: T_{amb} = 25 °C; active mode entered executing code `while(1){}` from flash; all peripherals disabled in the SYSAHBCLKCTRL register; all peripheral clocks disabled; internal pull-up resistors disabled; BOD disabled.

(1) System oscillator and system PLL disabled; IRC enabled.

(2) System oscillator and system PLL enabled; IRC disabled.

(3) System oscillator enabled; IRC and system PLL disabled.

Fig 6. Active mode: Typical supply current I_{DD} versus supply voltage $V_{DD(3V3)}$ for different system clock frequencies (all peripherals disabled)



Conditions: $V_{DD(3V3)}$ = 3.3 V; active mode entered executing code `while(1){}` from flash; all peripherals disabled in the SYSAHBCLKCTRL register; all peripheral clocks disabled; internal pull-up resistors disabled; BOD disabled.

(1) System oscillator and system PLL disabled; IRC enabled.

(2) System oscillator and system PLL enabled; IRC disabled.

(3) System oscillator enabled; IRC and system PLL disabled.

Fig 7. Active mode: Typical supply current I_{DD} versus temperature for different system clock frequencies (peripherals disabled)

11.4 Internal oscillators

Table 14. Dynamic characteristic: internal oscillators
T_{amb} = −40 °C to +85 °C; $V_{DD(3V3)}$ over specified ranges.[1]

Symbol	Parameter	Conditions	Min	Typ[2]	Max	Unit
$f_{osc(RC)}$	internal RC oscillator frequency	-	11.88	12	12.12	MHz

[1] Parameters are valid over operating temperature range unless otherwise specified.

[2] Typical ratings are not guaranteed. The values listed are at nominal supply voltages.

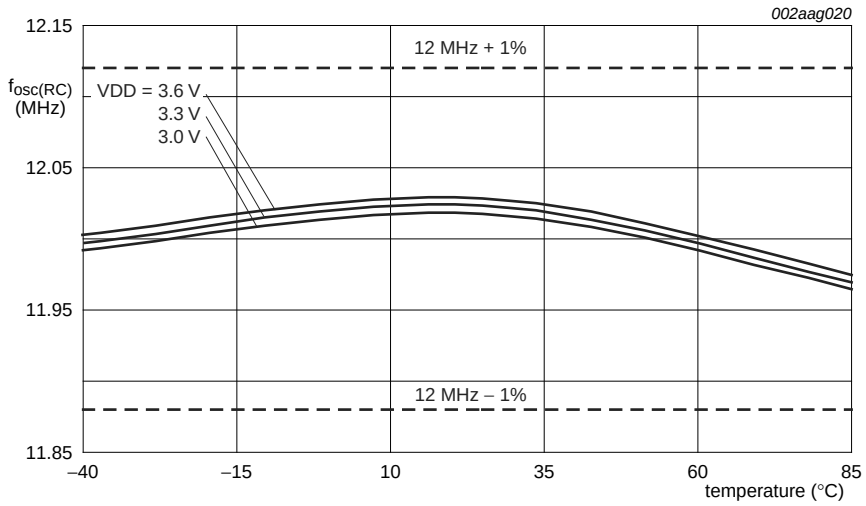


Fig 22. Internal RC oscillator frequency versus temperature

Table 15. Dynamic characteristics: Watchdog oscillator

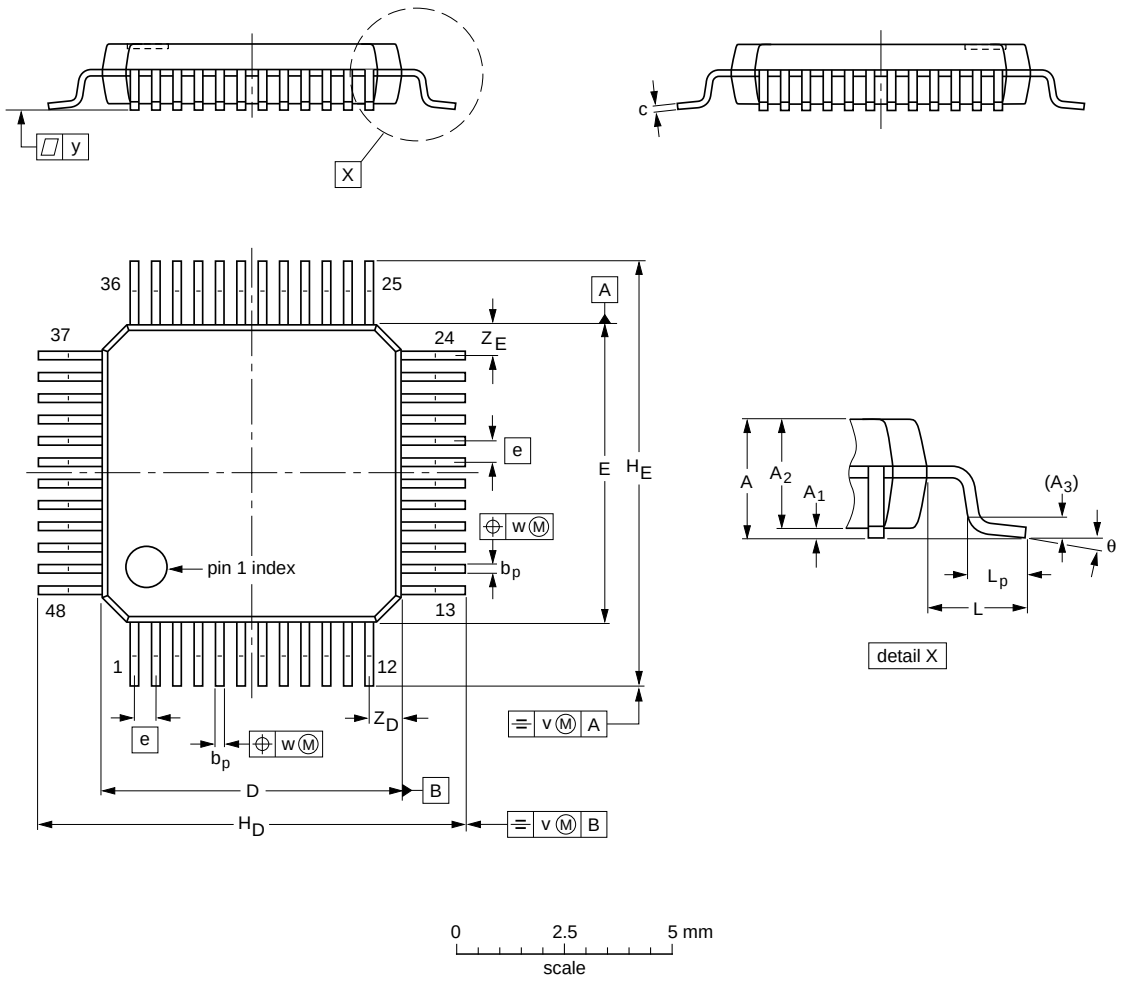
Symbol	Parameter	Conditions		Min	Typ[1]	Max	Unit
$f_{osc(int)}$	internal oscillator frequency	DIVSEL = 0x1F, FREQSEL = 0x1 in the WDTOSCCTRL register;	[2][3]	-	7.8	-	kHz
		DIVSEL = 0x00, FREQSEL = 0xF in the WDTOSCCTRL register	[2][3]	-	1700	-	kHz

[1] Typical ratings are not guaranteed. The values listed are at room temperature (25 °C), nominal supply voltages.

[2] The typical frequency spread over processing and temperature (T_{amb} = −40 °C to +85 °C) is ±40 %.

[3] See the *LPC122x user manual*.

LQFP48: plastic low profile quad flat package; 48 leads; body 7 x 7 x 1.4 mm **SOT313-2**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_D	H_E	L	L_p	v	w	y	$Z_D^{(1)}$	$Z_E^{(1)}$	θ
mm	1.6	0.20 0.05	1.45 1.35	0.25	0.27 0.17	0.18 0.12	7.1 6.9	7.1 6.9	0.5	9.15 8.85	9.15 8.85	1	0.75 0.45	0.2	0.12	0.1	0.95 0.55	0.95 0.55	7^o 0^o

Note

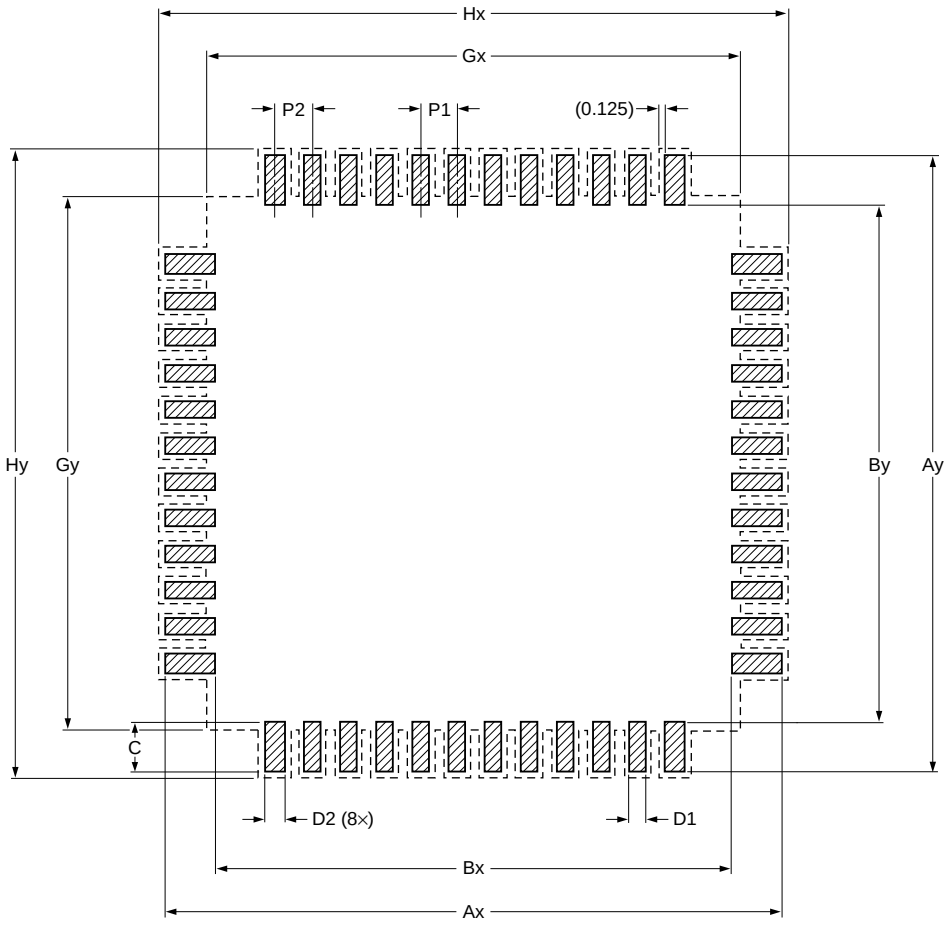
1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT313-2	136E05	MS-026				~~00-01-19~~ 03-02-25

Fig 26. Package outline SOT313-2 (LQFP48)

14. Soldering

Footprint information for reflow soldering of LQFP48 package **SOT313-2**



Generic footprint pattern

Refer to the package outline drawing for actual layout

solder land

occupied area

DIMENSIONS in mm

P1	P2	Ax	Ay	Bx	By	C	D1	D2	Gx	Gy	Hx	Hy
0.500	0.560	10.350	10.350	7.350	7.350	1.500	0.280	0.500	7.500	7.500	10.650	10.650

sot313-2_fr

Fig 27. Reflow soldering of the LQFP48 package